

## LC-12-3

### "An Integrated SOS/FET Biosensor"

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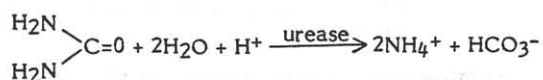
#### (Summary)

A monolithically integrated biosensor has been realized using SOS/FET (Silicon on Sapphire/Field Effect Transistor) technology, which makes it possible to measure a very small sample and to make measurements in a body, such as in a vein.

The integrated biosensor proposed in this paper (Fig. 1) adopts SOS/ISFET (Silicon on Sapphire/Ion Sensitive Field Effect Transistor), which is fabricated in a silicon island on the sapphire substrate and is sensitive to hydrogen ions ( $H^+$ ). The silicon island is easily isolated from the other FETs and a measured solution, because sapphire is a good dielectric material. Its inherent dielectric isolation property makes SOS/FET very suitable for use in chemical sensors and biosensors, which are used for making measurements in a solution.

The integrated SOS/FET biosensor consists of two kinds of SOS/ISFETs, which are made on the same chip. One SOS/ISFET has an immobilized enzyme (urease) membrane on the surface. The other has a membrane which has inactivated enzyme. A gold layer is deposited on the sapphire back surface and works as a pseudo reference electrode.

At the immobilized enzyme membrane, urease catalyzes the hydrolysis of urea according to the following reaction and changes pH.



By measuring a differential output between the two SOS/ISFETs, only pH change due to urea hydrolysis can be detected.

SOS/FET technology has also made it possible to integrate the biosensor by using conventional IC (Integrated Circuit) fabrication processes, such as spin coating and photolithography. Main integrated SOS/FET biosensor fabrication processes are;

- 1) Etch an island from the Si layer
- 2) Boron (B) ion implantation to Si
- 3) Phosphor (P) ion implantation to source and drain region
- 4) Gate oxidation ( $1000\text{\AA}$  thick  $SiO_2$ )
- 5) Phosphor (P) ion implantation to gate region for a threshold voltage control
- 6) Chemical vapor deposition of a silicon nitride ( $Si_3N_4$ ) layer, which works as an ion sensitive membrane
- 7) Sputter deposition of gold (Au) on the sapphire backsurface to make a pseudo reference electrode

- 8) Spin coat an acetyl cellulose layer containing glutaraldehyde and 1,8 diamino-4-aminomethyloctane
- 9) Immobilize urease
- 10) Inactivate immobilized urease except at the gate region for the urea sensitive SOS/FET
- 11) Scribe the wafer and connect wires.

As shown above, the proposed integrated SOS/FET biosensor was fabricated by IC technology, which contributes to miniaturization of the biosensors and to obtaining uniform sensor characteristics.

A measurement circuit for the proposed biosensor is shown in Fig. 2. Figure 3 shows the response curves for the urea concentration measurement. In Fig. 3, line S1 shows the output from the urea sensitive SOS/FET and line S2 shows the differential output between the two SOS/FETs on the same chip. Drift caused by the potential change in the solution is cancelled in line S2. Figure 4 shows a relationship between urea concentration and the differential output. Urea concentrations in the from 10 to 100 mg/dl range were detected by the differential response.

These results show that a miniaturized biosensor can be easily achieved by SOS/FET technology, which enables a direct IC fabrication process application. The proposed integrated SOS/FET biosensor can be set in a catheter or in a needle. It becomes very useful in medical application fields.

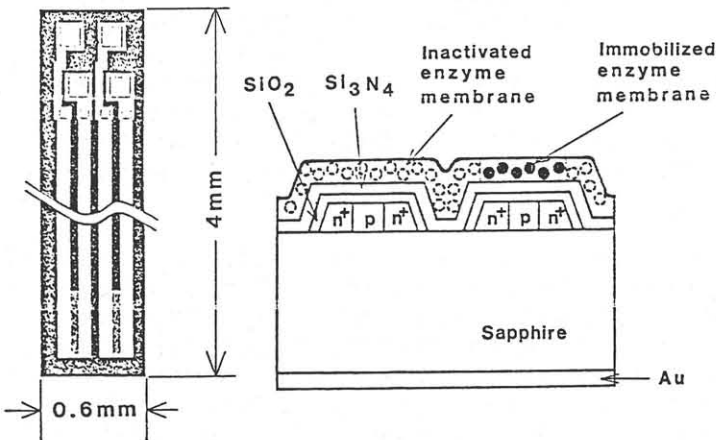


Fig. 1 Proposed integrated SOS/FET biosensor structure.

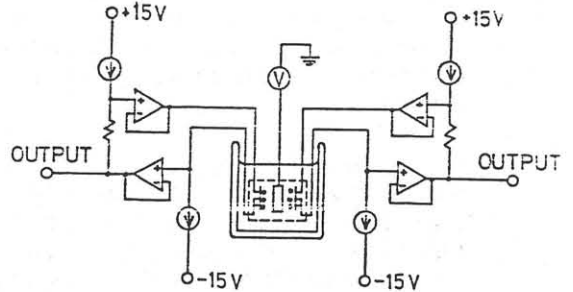


Fig. 2 Proposed biosensor measurement circuit.

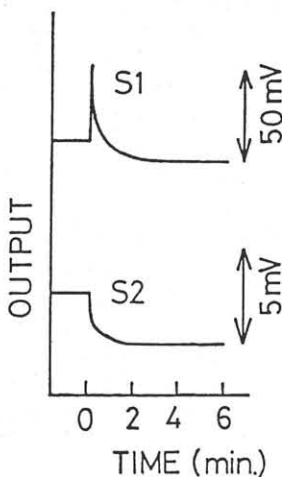


Fig. 3 Response curves for urea FET (S1), and differential output (S2). Urea is added into the buffer solution at time=0.

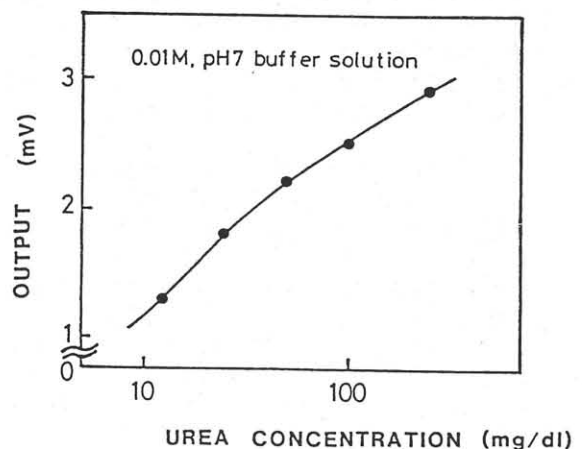


Fig. 4 Relationship between differential output and urea concentration